

Top View

www.vishay.com

Vishay Siliconix

N-Channel 20 V (D-S) Fast Switching MOSFET

Bottom View

PRODUCT SUMMARY							
V _{DS} (V)	20						
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0053						
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0078						
Q _g typ. (nC)	14						
I _D (A)	21.1						
Configuration	Single						

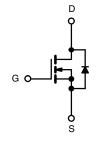
FEATURES

- TrenchFET® Gen II power MOSFET
- PWM optimized
- 100 % R_q tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



APPLICATIONS

- Synchronous rectification
- Synchronous buck



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH110DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless	otherwise no	ted)			
PARAMETER		SYMBOL	10 s	STEADY STATE	UNIT	
Drain-source voltage		V _{DS}	20	20	V	
Gate-source voltage		V _{GS}	± 20	± 20	V	
Continuous drain current (T _{.I} = 150 °C) ^a	T _A = 25 °C	I _D	21.1	13.5		
Continuous drain current (1 _J = 150 °C) ^a	T _A = 70 °C		16.9	10.8		
Pulsed drain current		I _{DM}	60	60	Α	
Continuous source current (diode conduction) a		I _S	3.2	1.3		
Single avalanche current	l 0.1 mall	I _{AS}	35	35		
Single avalanche energy L = 0 1 mH		E _{AS}	61	61	mJ	
Maximum navver discination 3	T _A = 25 °C	Б	3.8	1.5	W	
Maximum power dissipation ^a	T _A = 70 °C	P_D	2	0.8	VV	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150			
Soldering recommendations (peak temperature) b, c		-	260		°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^a	t ≤ 10 s	В	24	33	
Waximum junction-to-ambient -	Steady state	R _{thJA}	65	81	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.9	2.4	

Notes

- a. Surface mounted on 1" x 1" FR4 board
- a. Surface modified (www.vishay.com/doc?73257). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



www.vishay.com Vishay Siliconix

SPECIFICATIONS (T _J = 25 °C	C, unless oth	nerwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.5	-	2.5	V
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	la sa	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
zero gate voltage drain current	I _{DSS}	V_{DS} = 20 V, V_{GS} = 0 V, T_J = 55 °C	-	-	5	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 V$, $V_{GS} = 10 V$	40	-	-	Α
Drain-source on-state resistance a	В	$V_{GS} = 10 \text{ V}, I_D = 21.1 \text{ A}$	-	0.0044	0.0053	5 V 000 nA μA A 153 178 S 2 V I nC 1 Ω 0 ns 5 ns 6 ns
Diaiii-source oii-state resistance "	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 17.4 \text{ A}$	-	0.0064	0.0078	
Forward transconductance a	9 _{fs}	V _{DS} = 15 V, I _D = 21.1 A	-	71	-	S
Diode forward voltage ^a	V _{SD}	I _S = 3.2 A, V _{GS} = 0 V	-	0.8	1.2	V
Dynamic ^b						
Total gate charge	Q_g		-	14	21	nC
Gate-source charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 21.1 \text{ A}$	-	7	-	
Gate-drain charge	Q_{gd}		-	4.5	-	
Gate resistance	R_g	f = 1 MHz	0.7	1.4	2.1	Ω
Turn-on delay time	t _{d(on)}		-	12	20	
Rise time	t _r	V_{DD} = 10 V, R_L = 10 Ω	-	10	15	
Turn-off delay time	t _{d(off)}	$I_D \cong 1$ A, $V_{GEN} = 10$ V, $R_g = 6$ Ω	=	36	55	ns
Fall time	t _f		-	10	15	
Body diode reverse recovery time	t _{rr}		-	30	60	
Body diode reverse recovery charge	Q _{rr}	$I_F = 3.2 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$	-	25	50	nC
Reverse recovery fall time	ta	i _F = 3.2 A, αι/αι = 100 A/μS	-	14	-	no
Reverse recovery rise time	t _b		-	16	-	ns

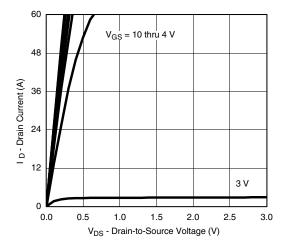
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

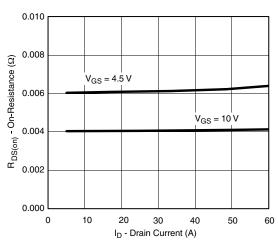
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



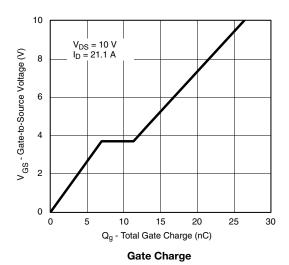
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

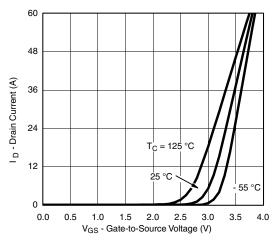


Output Characteristics

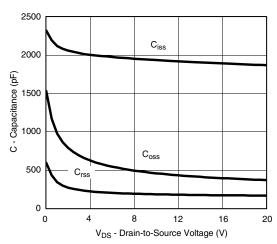


On-Resistance vs. Drain Current

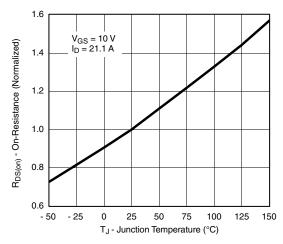




Transfer Characteristics



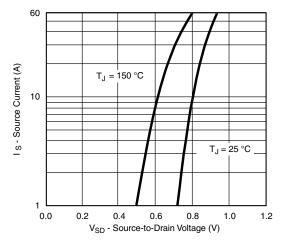
Capacitance



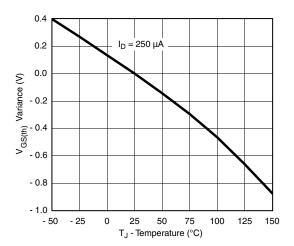
On-Resistance vs. Junction Temperature



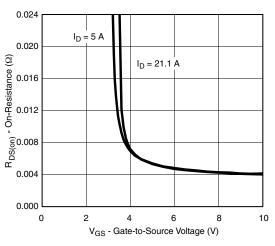
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



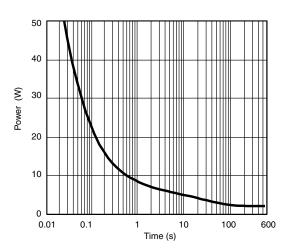
Source-Drain Diode Forward Voltage



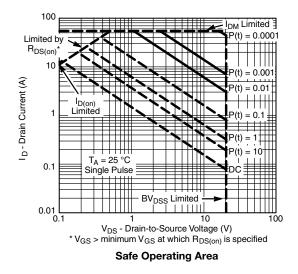
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

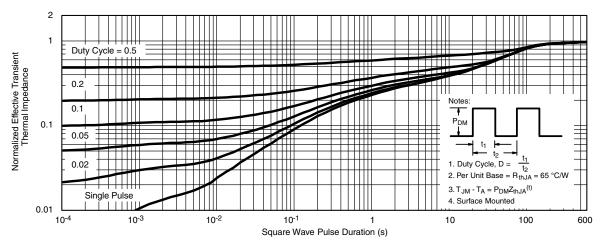


Single Pulse Power, Junction-to-Ambient

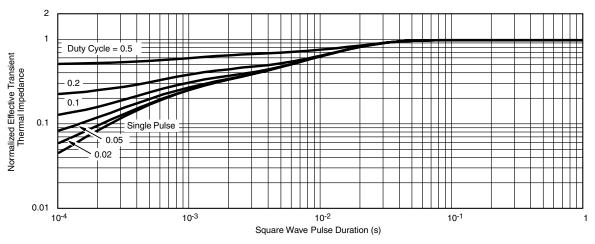




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

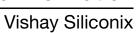


Normalized Thermal Transient Impedance, Junction-to-Ambient



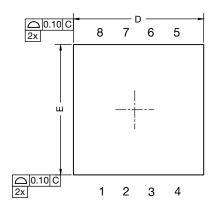
Normalized Thermal Transient Impedance, Junction-to-Case

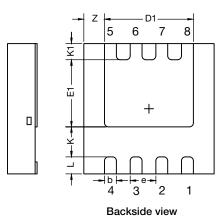
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?79230.

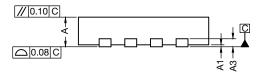




PowerPAK® 1212-SWLH







DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.82	0.90	0.98	0.032	0.035	0.038	
A1	0	-	0.05	0	-	0.002	
A3	0.20 ref.				0.008 ref.		
b	0.30 BSC				0.012 BSC		
D	3.30 BSC			0.130 BSC			
D1	2.15	2.25	2.35	0.084	0.088	0.092	
E	3.30 BSC			0.130 BSC			
E1	1.60	1.70	1.80	0.063 0.067		0.071	
е	0.65 BSC			0.026 BSC			
K	0.76 typ.			0.030 typ.			
K1	0.41 typ.			0.016 typ.			
L	0.43 BSC			0.017 BSC			
Z		0.525 typ.	0.525 typ. 0.021 typ.				

DWG: 6062



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

SISH110DN-T1-GE3